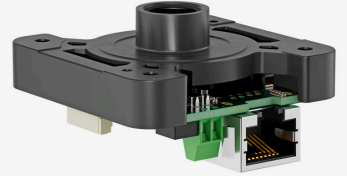
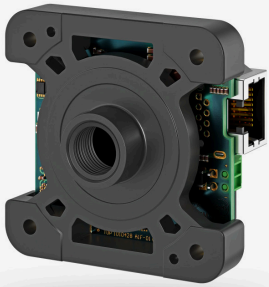


**In development**

The model is not yet in series production, but will be introduced shortly.

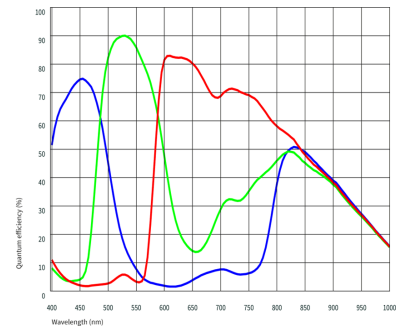


## Specification

**- PRELIMINARY -**

### Sensor

Sensor type	CMOS Color
Shutter	Rolling shutter
Sensor characteristic	Linear
Readout mode	-
Pixel Class	2 MP
Resolution	2.12 Mpix
Resolution (h x v)	1936 x 1096 Pixel
Aspect ratio	16:9
ADC	12 bit
Color depth (camera)	12 bit
Optical sensor class	1/3"
Optical Size	5.614 mm x 3.178 mm
Optical sensor diagonal	6.45 mm (1/2.48")
Pixel size	2.9 µm
Manufacturer	Sony
Sensor Model	IMX662-AAQR1-C
Gain (master/RGB)	31.6x/16x
AOI horizontal	same frame rate
AOI vertical	increased frame rate
AOI image width / step width	256 / 2
AOI image height / step width	2 / 2
AOI position grid (horizontal/vertical)	2 / 2
Binning horizontal	increased frame rate
Binning vertical	increased frame rate
Binning method	
Binning factor	-
Subsampling horizontal	
Subsampling vertical	
Subsampling method	M/C automatic
Subsampling factor	-



Subject to technical modifications (2025-01-15)

## Model

Frame rate freerun mode	59 fps
Frame rate trigger (continuous)	59 fps
Frame rate trigger (maximum)	61 fps
Exposure time (minimum - maximum)	0.013 ms - 1999 ms
Power consumption	2.1 W - 3.1 W

## Ambient conditions

For PCB versions, refer to the separate hints in the respective documentation.

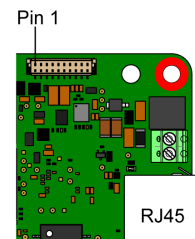
Allowed device temperature during operation	0 °C - 35 °C / 32 °F - 95 °F
Allowed device temperature during storage	-20 °C - 60 °C / -4 °F - 140 °F
Humidity (relative, non-condensing)	20 % - 80 %

## Connectors

Interface connector	GigE RJ45
I/O connector	10-pin Wuerth connector (WR-WTB 1.00 mm)
Power supply	12 V - 24 V

## Pin assignment I/O connector

1	Power supply (VCC) 12-24 V
2	Power supply, ground
3	General Purpose I/O (GPIO) 2, 3.3 V
4	General Purpose I/O (GPIO) 1, 3.3 V
5	I2C SCL (signal clock) 3.3 V
6	I2C SDA (signal data) 3.3 V
7	Trigger input without optocoupler 3.3 V
8	Flash output without optocoupler 3.3 V
9	Ground (GND)
10	Voltage output 3.3 V



## Design

Lens Mount	S-Mount
IP code	-
Dimensions H/W/L	50.0 mm x 50.0 mm x 28.5 mm
Mass	30 g

## Features

### Image Acquisition

Freerun	✓
Software trigger	✓
Hardware trigger	✓
Trigger controlled exposure	-
Denoisier	✓
Long exposure	-
Line scan	-
Line scan highspeed	-
Global start	-

### Flashing

Flashing	-
PWM flashing	-

Image Adjustments	Auto exposure	-
	Auto gain	-
	Auto whitebalance	-
	Color correction	-
	Gamma	-
	LUT	-
	Mirror/flip	X/Y
On-board Image Processing	Pixel formats	BayerRG8 BayerRG10p BayerRG12 BayerRG12p BayerRG10
	Region of interest	✓
	Decimation (FPGA)	✓
	Decimation (Sensor)	-
	Binning (FPGA)	-
	Binning (Sensor)	2x2 Increases frame rate.
Others	IP settings	✓
	Bandwidth management	✓
	Chunks	-
	Sequencer	-
	PTP	✓
	Firmware update	✓
	1st supported firmware version	